

Model	No.:
Date /	Rev.

FYLS-0805IRAC 2020.10.31 / A

# **PRODUCT SPECIFICATION**

Model No.: FYLS-0805IRAC

# Features:

SMD Type
Size (mm):2.00*1.25*0.80
Emitting Color: Infrared.
Lens Color: Water clear.
SMT package
Suitable for all SMT assembly and soldering method
Pb-free Reflow soldering application
RoHS Compliant
MSL:4

EORYARD NICS
Applications:
Mouse
Optoelectronic switch
Copiers
Scanners
Amusement machines
Surveillance system
Wireless communication



CUSTOMER APPROVED SIGNATURES	APPROVED BY	CHECKED BY	PREPARED BY

# NINGBO FORYARD OPTOELECTRONICS CO., LTD.

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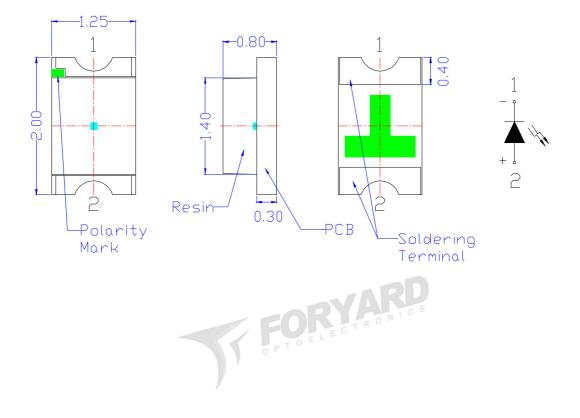
<u>Http://www.foryard.com</u>

Zip:315103

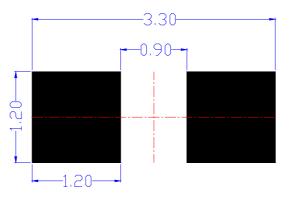


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### Mechanical Dimensions



### Recommend Soldering pad design(unit=mm)



Notes:

1. Dimension in millimeter, tolerance is  $\pm 0.10$ .

2.Angle:±5°

3. The specifications, characteristics and technical data described in the datasheet are subject to change without prior notice.

4. The drawing is different from the actual one, please refer to the sample.

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# ■ Absolute Maximun Ratings(Ta=25°C)

Parameter	Symbol	MAX.	Unit	
Power Dissipation	PD	130	mW	
Peak Forward Current*	IFP	65	mA	
Continuous Forward Current	IF	25	mA	
Reverse Voltage	VR	5	V	
Operating Temperature Range	Topr	-30~ +85	°C	
Storage Temperature Range	Tstg	-40~ +85	°C	
Soldering Temperature	Tsol	Reflow soldering : 260°C, 10s		
	1501	Hand soldering : 300°C, 3s		

\*1/10 Duty Cycle, 0.1ms Pulse Width

# ■ Typical Electrical &Optical Charcteristics(Ta=25°C)

Symbol	Test Condition	Min.	Тур.	Max.	Unit
Ee	IF=20mA	0.2	0.8		mW/si
V <sub>F</sub>	IF=20mA		1.2	1.65	V
λр	IF=20mA		940		nm
Δλ	IF=20mA		45		nm
20 <sub>1/2</sub>	□ F=20mA		140		Deg
I <sub>R</sub>	VR=5V			10	μA
	Ee    V <sub>F</sub> λp    Δλ    2θ <sub>1/2</sub>	EeIF=20mA $V_F$ IF=20mA $\lambda p$ IF=20mA $\Delta \lambda$ IF=20mA $2\theta_{1/2}$ IF=20mA	Ee  IF=20mA  0.2    V <sub>F</sub> IF=20mA     λp  IF=20mA     Δλ  IF=20mA     2θ <sub>1/2</sub> IF=20mA	Ee  IF=20mA  0.2  0.8 $V_F$ IF=20mA   1.2 $\lambda p$ IF=20mA   940 $\Delta \lambda$ IF=20mA   45 $2\theta_{1/2}$ IF=20mA   140	Ee  IF=20mA  0.2  0.8 $V_F$ IF=20mA   1.2  1.65 $\lambda p$ IF=20mA   940 $\Delta \lambda$ IF=20mA   45 $2\theta_{1/2}$ IF=20mA   140

## Material

Item	Reflector	Wire	Encapsulate	Chip
Material	/	Gold	Ероху	AlGaAs/Si

Note:

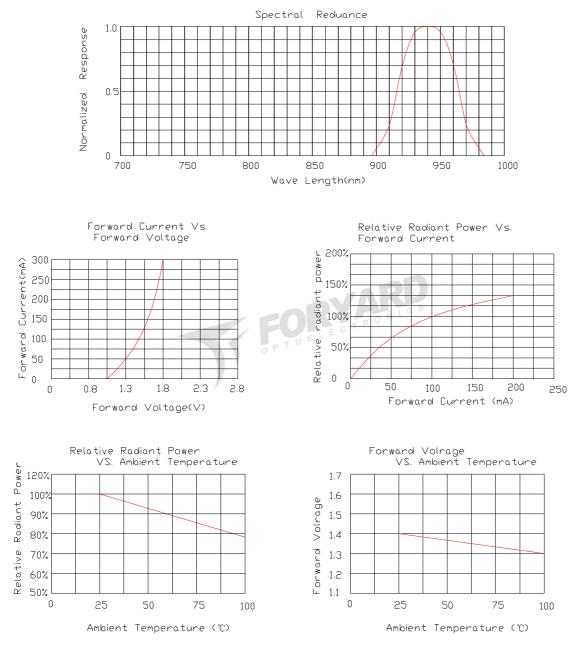
1.Luminous Intensity is based on the Foryard standards.

2.Pay attention about static for InGaN



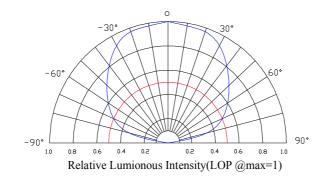
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## Electrical-Optical Characteristics-





## Radiation pattern-

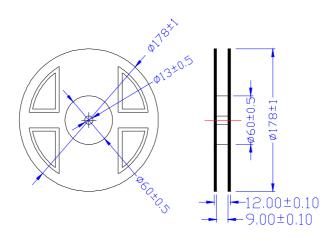




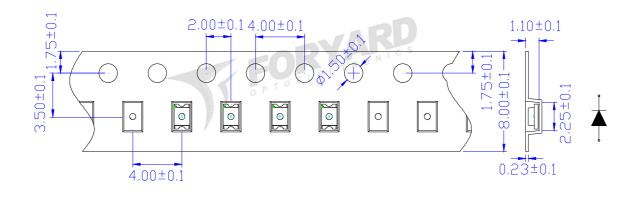
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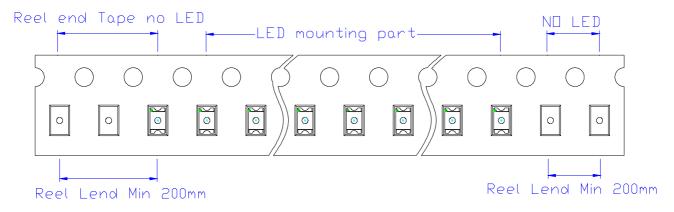
## Package-

1. Reel Dimension



# 2. Tape Dimension





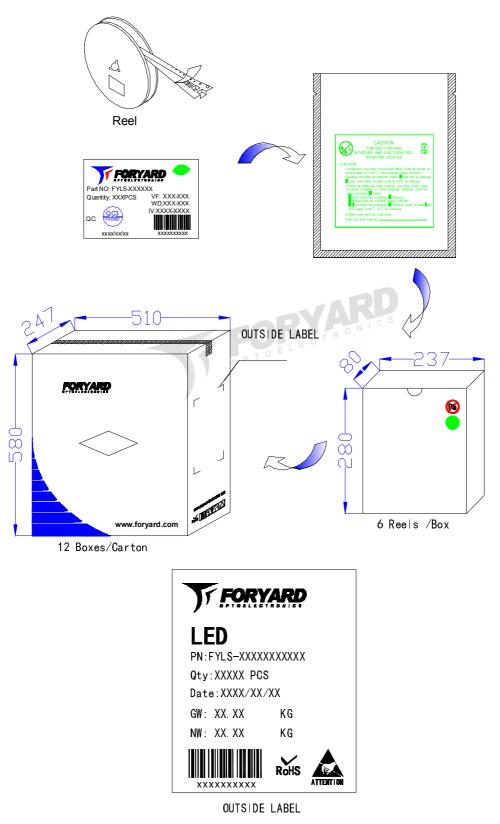
## Notice:

1. Tolerance unless mentioned is  $\pm$ 0.2mm



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3.Packing Diagram



## Notice:

1.Quantity:4000 PCS/Reel

2. The specifications are subject to change without notice. Please contact us for updated information.

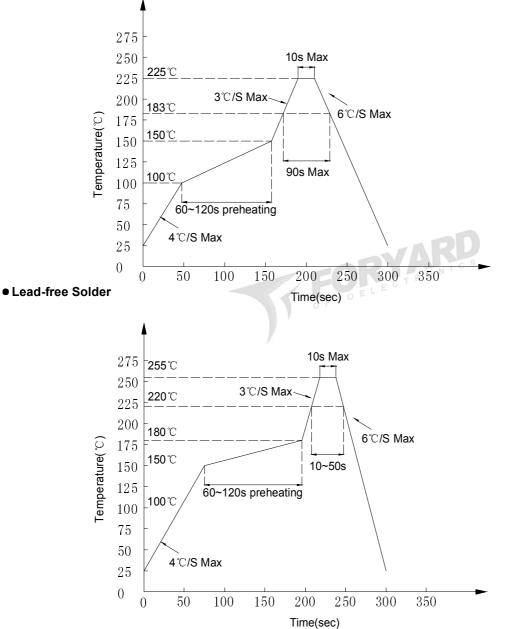


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#### Soldering Characteristics-

## Reflow Soldering

Lead Solder



#### Notes:

1.Although the recommended soldering conditions are specified in above table, reflow or hand soldering at the lowest possible temperature is desired for the LEDs.

2.A rapid-rate process is not recommended for cooling the LEDs down from the peak temperature.

3.All temperatures refer to solder Pad.

## Hand Soldering

Soldering temperature	300℃ Max. (25W Max.)	One time olny
Soldering time	3 ±1sec	One time only



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#### Handling of Silicone Resin LEDs-

#### Handling Indications

When handling the product, do not touch it directly with bare hands as it may contaminate the surface and affect on optica characteristics. In the worst cases, excessive force to the product might result in catastrophic failure due to package damage and/or wire breakage.



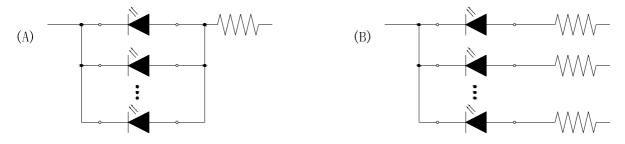
When handling the product with tweezers, LEDs should only be handled from the side and make sure that excessive force is not applied to the resin portion of the pordct. Failure to comply can cause the resin portion of the product to be cut, chipped, delaminated and/or deformed, and wire to be broken, and thus resulting in catastrophic failure.





#### Recommended circuit-

• In designing a circuit, the current through each LED must not exceed the absolute maximum rating specified for each LEC It is recommended to use Circuit B which regulates the current flowing through each LED. In the meanwhile, when driving LE with a constant voltage in Circuit A, the current through the LEDs may vary due to the variation in forward voltage(VF) of the LEDs. In the worst case, some LED may be subjected to stresses in excess of the absolute maximum rating.



• This product should be operated in forward bias. A driving circuit must be designed so that the product is not subjected to either forward or reverse voltage while it is off. In particular, if a reverse voltage is continuously applied to the product; such operation can cause migration resulting in LED damage.

#### Storage-

Storage Conditions

1.Unopened moisture barrier bag (MBB) shall be stored at temperature below  $5^{\circ}C \sim 30^{\circ}C$ , with humidity below  $60^{\circ}RH$ . 2.Before the MBB be opened, check if have the air leakage, if have, then need to bake at  $65^{\circ}C \sim 70^{\circ}C$  for 24 hours.

3.After the MBB has been opened, the LEDs which need for reflow soldering or other soldering methods, must be used according to below:

- a: Must finish the soldering in 72hours
- b: Stored with the humidity below 30%RH
- c: If not finish the soldering in 72hours, need to bake the LED again at 65 ℃~70 ℃ for 24hours